Octal buffer/line driver with 5 V tolerant inputs/outputs; inverting; 3-state

Rev. 8 — 29 November 2011

Product data sheet

1. General description

The 74LVC240A is an octal inverting buffer/line driver with 3-state outputs. The 3-state outputs are controlled by the output enable inputs 1OE and 2OE. A HIGH on nOE causes the outputs to assume a high-impedance OFF-state. Schmitt trigger action at all inputs makes the circuit highly tolerant of slower input rise and fall times.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices as translators in mixed 3.3 V or 5 V applications.

The 74LVC240A is functionally identical to the 74LVC244A except that the 244 has non-inverting outputs.

2. Features and benefits

- 5 V tolerant inputs for interlacing with 5 V logic
- Supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- High-impedance when V_{CC} = 0 V
- Complies with JEDEC standard:
 - JESD8-7A (1.65 V to 1.95 V)
 - ◆ JESD8-5A (2.3 V to 2.7 V)
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - ◆ HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115B exceeds 200 V
 - CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

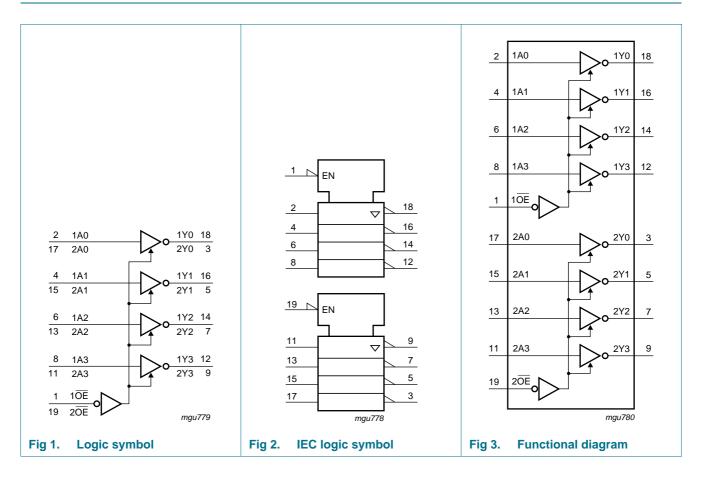


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3. Ordering information

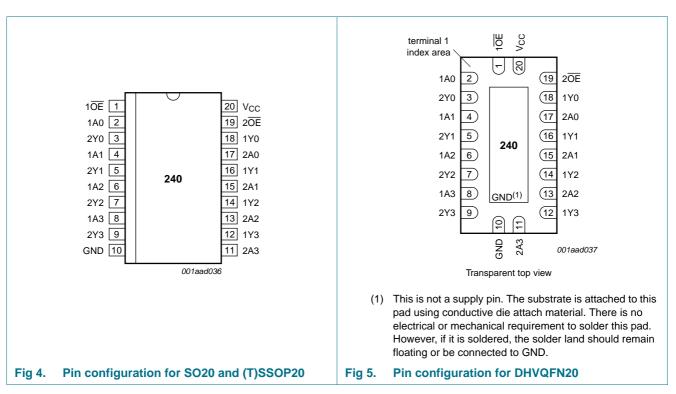
Type number	Package			
	Temperature range	Name	Description	Version
74LVC240AD	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1
74LVC240ADB	–40 °C to +125 °C	SSOP20	plastic shrink small outline package; 20 leads; body width 5.3 mm	SOT339-1
74LVC240APW	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1
74LVC240ABQ	–40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body $2.5 \times 4.5 \times 0.85$ mm	SOT764-1

4. Functional diagram



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5. Pinning information



5.1 Pinning

5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
1 <mark>OE</mark>	1	output enable input (active LOW)
2 <mark>0E</mark>	19	output enable input (active LOW)
1A[0:3]	2, 4, 6, 8	data input
2A[0:3]	17, 15, 13, 11	data input
1Y[0:3]	18, 16, 14, 12	data output
2Y[0:3]	3, 5, 7, 9	data output
GND	10	ground (0 V)
V _{CC}	20	power supply

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6. Functional description

Table 3.	Function selection ^[1]

Inputs nOE		Output
nOE	nAn	nYn
L	L	Н
L	Н	L
Н	Х	Z

[1] H = HIGH voltage level

L = LOW voltage level

X = don't care

Z = high-impedance OFF-state

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V ₁ < 0	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
Ι _{ΟΚ}	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0	-	±50	mA
Vo	output voltage	output HIGH or LOW state	[2] -0.5	V _{CC} + 0.5	V
		output 3-state	<u>[2]</u> –0.5	+6.5	V
l _O	output current	$V_{O} = 0 V \text{ to } V_{CC}$	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to +125 \ ^{\circ}C$	<u>[3]</u>	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] For SO20 packages: above 70 °C derate linearly with 8 mW/K.
 For (T)SSOP20 packages: above 60 °C derate linearly with 5.5 mW/K.
 For DHVQFN20 packages: above 60 °C derate linearly with 4.5 mW/K.

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8. Recommended operating conditions

Table 5.	Recommended operating co	onditions				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW state	0	-	V _{CC}	V
		output 3-state	0	-	5.5	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall	V_{CC} = 1.65 V to 2.7 V	0	-	20	ns/V
	rate	V_{CC} = 2.7 V to 3.6 V	0	-	10	ns/V

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	–40 °C to	o +125 ℃	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
VIH	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	V_{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		V_{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
V _{IL}	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V_{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		$V_{CC} = 2.7 V \text{ to } 3.6 V$	-	-	0.8	-	0.8	V
V _{OH} HIGH-level output voltage		$V_{I} = V_{IH} \text{ or } V_{IL}$						
	-	$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_0 = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = 100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	-	-	0.2	-	0.3	V
		$I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		I_0 = 12 mA; V_{CC} = 2.7 V	-	-	0.4	-	0.6	V
		$I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
lı	input leakage current	V_{CC} = 3.6 V; V_{I} = 5.5 V or GND	-	±0.1	±5	-	±20	μA

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Symbol	Parameter	Conditions	–40 °C to +85 °C			–40 °C to	Unit	
			Min	Typ[1]	Max	Min	Max	
I _{OZ}	OFF-state output current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{IH} \text{ or } V_{IL}; \ V_{CC} = 3.6 \ V; \\ V_{O} = 5.5 \ V \text{ or } \ GND; \end{array}$	-	±0.1	±10	-	±20	μA
I _{OFF}	power-off leakage current	$V_{CC} = 0$ V; V ₁ or V ₀ = 5.5 V	-	0.1	±10	-	±20	μΑ
I _{CC}	supply current	V_{CC} = 3.6 V; V_{I} = V_{CC} or GND; I_{O} = 0 A	-	0.1	10	-	40	μΑ
Δl _{CC}	additional supply current	per input pin; $V_{CC} = 2.7 V \text{ to } 3.6 V;$ $V_{I} = V_{CC} - 0.6 V; I_{O} = 0 A$	-	5	500	-	5000	μΑ
CI	input capacitance	$V_{CC} = 0 V \text{ to } 3.6 V;$ $V_{I} = GND \text{ to } V_{CC}$	-	5.0	-	-	-	pF

Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

Symbol	Parameter	Conditions	ditions -40 °C to +85 °C -40 °C to +125 °		o +125 ℃	Unit			
				Min	Typ <mark>[1]</mark>	Мах	Min	Max	
t _{pd} propagation		1An to 1Yn; 2An to 2Yn; see Figure 6	[2]						
	delay	V _{CC} = 1.2 V		-	16	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		1.0	5.7	12.7	1.0	14.6	ns
		V_{CC} = 2.3 V to 2.7 V		0.5	3.0	6.6	0.5	7.6	ns
		$V_{CC} = 2.7 V$		1.5	3.1	7.0	1.5	9.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.3	2.6	5.5	1.3	7.0	ns
t _{en}	enable time	10E to 1Yn; 20E to 2Yn; see Figure 7	[2]						
		V _{CC} = 1.2 V		-	19	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		1.5	6.3	15.9	1.5	18.3	ns
		V_{CC} = 2.3 V to 2.7 V		1.5	3.6	8.8	1.5	10.1	ns
		$V_{CC} = 2.7 V$		1.0	3.7	8.5	1.0	11.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.1	2.9	7.0	1.1	9.0	ns
t _{dis}	disable time	10E to 1Yn; 20E to 2Yn; see Figure 7	[2]						
		V _{CC} = 1.2 V		-	17	-	-	-	ns
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$		2.3	4.1	9.9	2.3	11.4	ns
		V_{CC} = 2.3 V to 2.7 V		1.0	3.4	5.6	1.0	6.5	ns
		$V_{CC} = 2.7 V$		1.5	3.1	7.5	1.5	9.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.4	2.9	6.0	1.4	7.5	ns
t _{sk(o)}	output skew time	$V_{CC} = 3.0 V \text{ to } 3.6 V$	<u>[3]</u>	-	-	1.0	-	1.5	ns

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$\frac{1}{10000000000000000000000000000000000$								
Symbol	Parameter	Conditions	–40 °C to +85 °C			–40 °C to	Unit	
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
C_{PD}		per buffer; $V_I = GND$ to V_{CC} [4]						
dissipation capacitance	V_{CC} = 1.65 V to 1.95 V	-	2.0	-		-	pF	
	capacitance	V_{CC} = 2.3 V to 2.7 V	-	5.2	-		-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	-	8.1	-		-	pF

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V, and 3.3 V respectively.

 $\label{eq:tpd} [2] \quad t_{pd} \text{ is the same as } t_{PLH} \text{ and } t_{PHL}.$

 t_{en} is the same as t_{PZL} and t_{PZH}

 t_{dis} is the same as t_{PLZ} and $t_{\text{PHZ}}.$

- [3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.
- [4] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $\mathsf{P}_{\mathsf{D}} = \mathsf{C}_{\mathsf{P}\mathsf{D}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}{}^2 \times \mathsf{f}_i \times \mathsf{N} + \Sigma(\mathsf{C}_{\mathsf{L}} \times \mathsf{V}_{\mathsf{C}\mathsf{C}}{}^2 \times \mathsf{f}_o) \text{ where:}$

 f_i = input frequency in MHz; f_o = output frequency in MHz

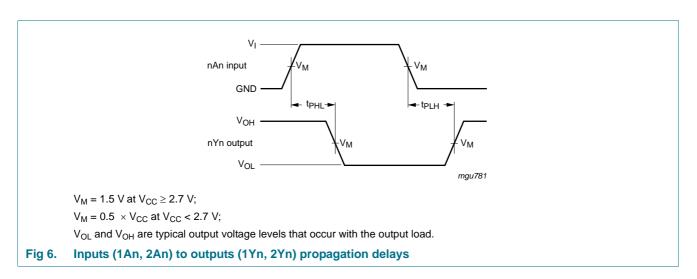
 C_L = output load capacitance in pF

 V_{CC} = supply voltage in Volts

N = number of inputs switching

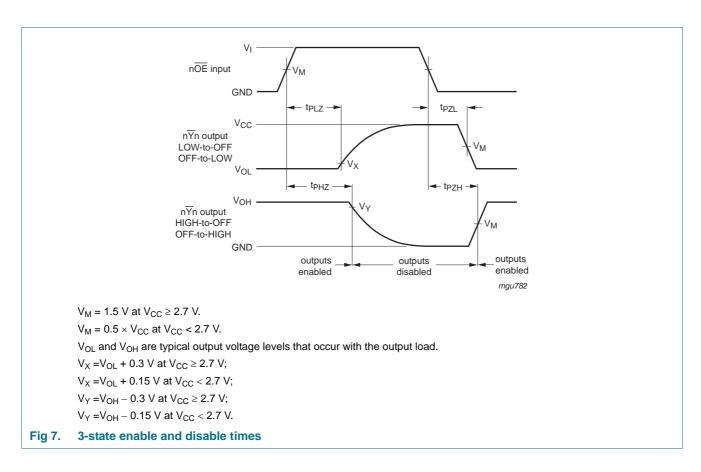
 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of the outputs

11. AC waveforms



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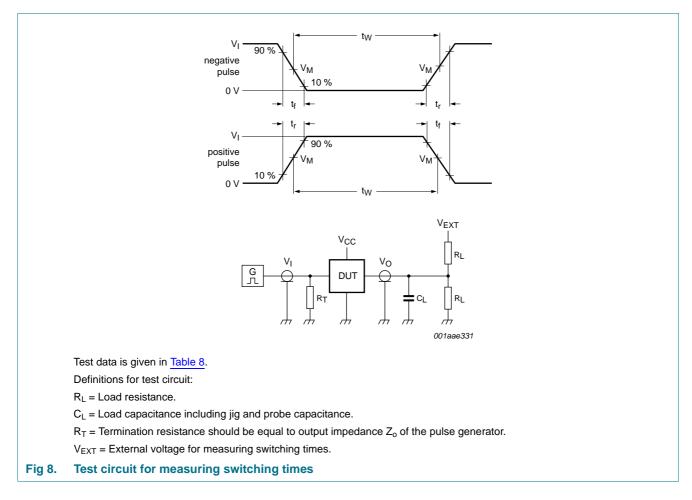


Table 8. Test data

Supply voltage	Input	Input		Load		V _{EXT}		
	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}	
1.2 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND	
1.65 V to 1.95 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
2.3 V to 2.7 V	V _{CC}	\leq 2 ns	30 pF	500 Ω	open	$2\times V_{CC}$	GND	
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	
3.0 V to 3.6 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	

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12. Package outline

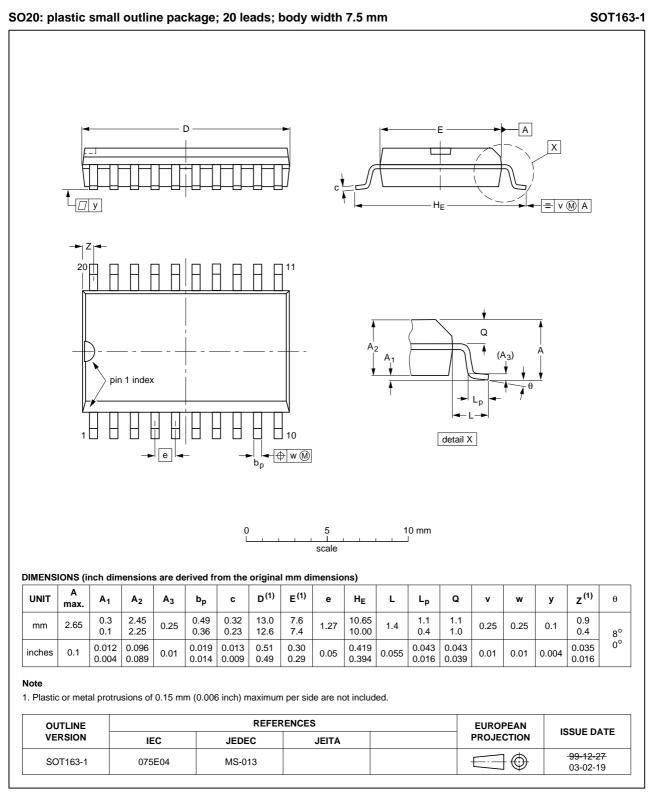


Fig 9. Package outline SOT163-1 (SO20)

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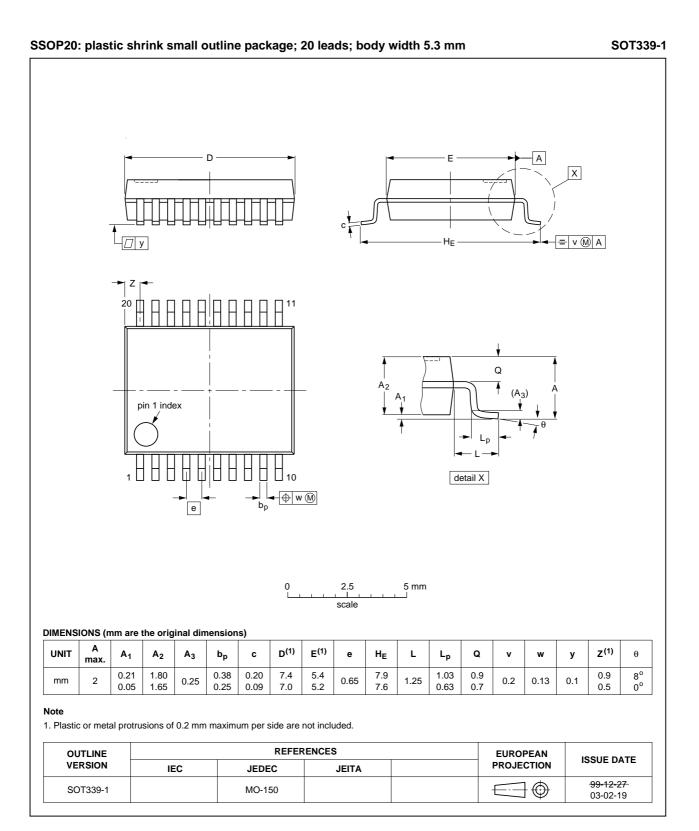


Fig 10. Package outline SOT339-1 (SSOP20)

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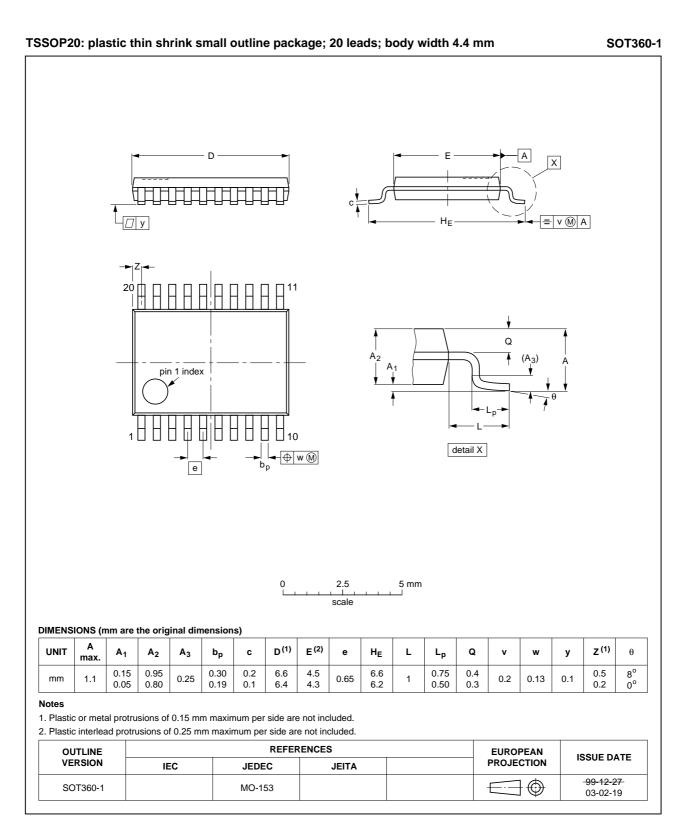
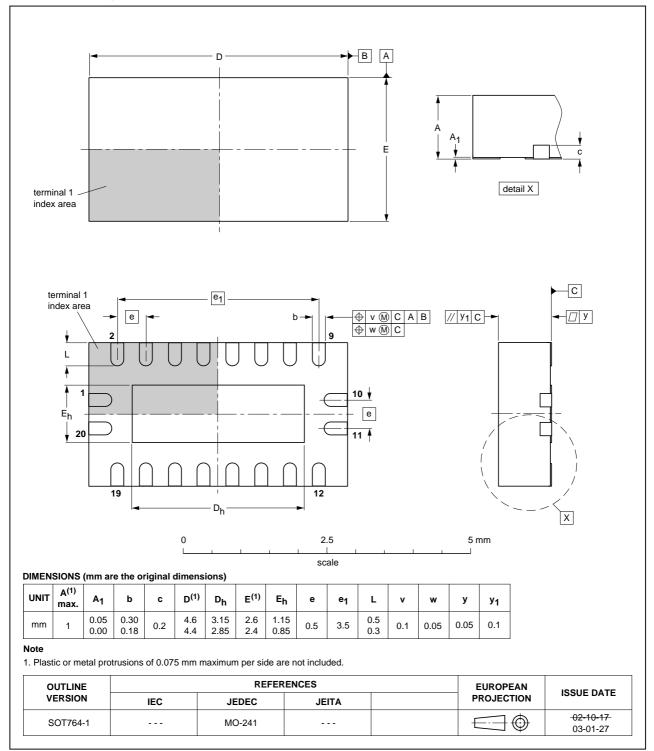


Fig 11. Package outline SOT360-1 (TSSOP20)

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DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

Fig 12. Package outline SOT764-1 (DHVQFN20)

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13. Abbreviations

Table 9. Abbreviations				
Acronym	Description			
CDM	Charged Device Model			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
HBM	Human Body Model			
MM	Machine Model			
TTL	Transistor-Transistor Logic			

14. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74LVC240 v.8	20111129	Product data sheet	-	74LVC240A v.7	
Modifications:	 <u>Table 7</u>: maximum values for lower voltage ranges changed (errata). 				
74LVC240A v.7	20111027	Product data sheet	-	74LVC240A v.6	
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 				
	 Legal texts have 	ve been adapted to the new comp	pany name where app	ropriate.	
	• <u>Table 4, Table</u>	5, <u>Table 6,</u> <u>Table 7</u> and <u>Table 8</u> : \	alues added for lower	voltage ranges.	
74LVC240A v.6	20031202	Product specification	-	74LVC240A v.5	
74LVC240A v.5	20030514	Product specification	-	74LVC240A v.4	
74LVC240A v.4	20021220	Product specification	-	74LVC240A v.3	
74LVC240A v.3	20021002	Product specification	-	74LVC240A v.2	
74LVC240A v.2	19980520	Product specification	-	74LVC240A v.1	
74LVC240A v.1	-	Product specification	-	-	

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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